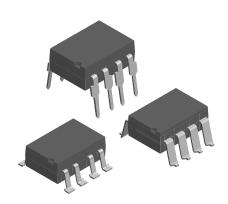
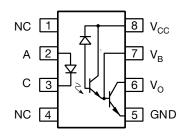


High Speed Optocoupler, 100 kBd, Low Input Current, Photodiode Darlington Output





LINKS TO ADDITIONAL RESOURCES











DESCRIPTION

High common mode transient immunity and very high current ratio together with 5300 V_{RMS} insulation are achieved by coupling and LED with an integrated high gain photo detector in an eight pin dual-in-line package. Separate pins for the photo diode and output stage enable TTL compatible saturation voltages with high speed operation.

Access to the base terminal allows adjustment to the gain bandwidth.

The 6N139 is suited for low power logic applications involving CMOS and low power TTL applications. A 400 % current transfer ratio with only 0.5 mA of LED current is guaranteed.

Caution: Due to the small geometries of this device, it should be handled with Electrostatic Discharge (ESD) precautions. Proper grounding would prevent damage further and/or degradation which may be induced by ESD.

FEATURES

- High current transfer ratio, 500 %
- Low input current, 1.6 mA
- High common mode rejection, 500 V/µs
- · Adjustable bandwidth-access to base
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ROHS COMPLIANT

APPLICATIONS

- Microprocessor system interface
- PLC, ATE input / output isolation
- EIA RS232 line receiver
- TTL, CMOS voltage level translation
- Multiplexed data transmission
- Digital control power supply
- Ground loop and electrical noise elimination

AGENCY APPROVALS

- UL 1577
- cUL
- DIN EN 60747-5-5 (VDE 0884-5), available with option 1



| ORDERING INFORMATION | | | | |
|----------------------------|--|--|--|--|
| 6 N 1 3 PART NUMBER | # - X 0 # # T PACKAGE OPTION TAPE AND REEL | | | |
| AGENCY CERTIFIED / PACKAGE | CTR (%) | | | |
| AGENOT GENTINED/T AGRAGE | 1.6 mA | | | |
| UL, cUL | > 500 | | | |
| DIP-8 | 6N139 | | | |
| SMD-8, option 7 | 6N139-X007, 6N139-X007T | | | |
| SMD-8, option 9 | 6N139-X009, 6N139-X009T | | | |
| UL, cUL, VDE (option 1) | > 500 | | | |
| DIP-8 | 6N139-X001 | | | |
| SMD-8, option 7 | 6N139-X017T | | | |
| SMD-8, option 9 | 6N139-X019T | | | |

Note

· For additional information on the available options refer to option information

| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | | | |
|--|------------------------------------|----------------------------------|-------------|------|--|--|--|--|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT | | | | |
| input | | | | | | | | |
| Reverse voltage | | V_R | 5 | V | | | | |
| Forward current | | I _F | 25 | mA | | | | |
| Average input current | | I _{f(avg)} | 20 | mA | | | | |
| Input power dissipation | | P _{diss} | 35 | mW | | | | |
| output | | | | | | | | |
| Supply and output voltage | Pin 8 to pin 5, pin 6 to pin 5 | V _{CC} , V _O | -0.5 to 18 | V | | | | |
| Emitter base reverse voltage | Pin 5 to pin 7 | | 0.5 | V | | | | |
| Peak input current | 50 % duty cycle - 1 ms pulse width | | 40 | mA | | | | |
| Peak transient input current | t _p ≤ 1 μs, 300 pps | | 1 | А | | | | |
| Output current | Pin 6 | I _O | 60 | mA | | | | |
| Output power dissipation | | P _{diss} | 100 | mW | | | | |
| coupler | | | | | | | | |
| Storage temperature | | T _{stg} | -55 to +150 | °C | | | | |
| Operating temperature | | T _{amb} | -55 to +100 | °C | | | | |
| Lead soldering temperature | t = 10 s | T _{sld} | 260 | °C | | | | |

Note

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
maximum ratings for extended periods of the time can adversely affect reliability.



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| ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | | |
|--|---|------------------|------|-------|------|-------|--|
| PARAMETER | TEST CONDITION SYMBOL MIN. | | TYP. | MAX. | UNIT | | |
| INPUT | | | | | | | |
| Input forward voltage | I _F = 1.6 mA | V_{F} | - | 1.4 | 1.7 | V | |
| Input reverse breakdown voltage | $I_R = 10 \mu A$ | B _{VR} | 5 | - | - | V | |
| Input capacitance | $f = 1 \text{ MHz}, V_F = 0$ | C _{IN} | - | 25 | | pF | |
| Temperature coefficient of forward voltage | I _F = 1.6 mA | | - | -1.8 | - | mV/°C | |
| ОИТРИТ | | | | | | | |
| | $I_F = 1.6 \text{ mA}, I_O = 8 \text{ mA}, V_{CC} = 4.5 \text{ V}$ | V _{OL} | - | 0.1 | 0.4 | V | |
| Logic low, output voltage (1) | $I_F = 5 \text{ mA}, I_O = 15 \text{ mA}, V_{CC} = 4.5 \text{ V}$ | V _{OL} | - | 0.15 | 0.4 | V | |
| | $I_F = 12 \text{ mA}, I_O = 24 \text{ mA}, V_{CC} = 4.5 \text{ V}$ | V _{OL} | - | 0.25 | 0.4 | V | |
| Logic high, output current (1) | $I_F = 0 \text{ mA}, V_{CC} = 18 \text{ V}$ | I _{OH} | - | 0.05 | 100 | μΑ | |
| Logic low supply current (1) | $I_F = 1.6$ mA, $V_O = OPEN$, $V_{CC} = 18$ V | I _{CCL} | - | 0.2 | 1.5 | mA | |
| Logic high supply current (1) | $I_F = 0$ mA, $V_O = OPEN$, $V_{CC} = 18 V$ | I _{CCH} | - | 0.001 | 10 | μΑ | |
| COUPLER | | | | | | | |
| Input output insulation leakage current | $45~\%$ relative humidity, $T_{amb} = 25~^{\circ}\text{C}, t = 5~\text{s}, V_{IO} = 3000~\text{V}_{DC}$ | | - | - | 1 | μA | |
| Coupling capacitance | f = 1 MHz | C _{IO} | - | 0.6 | - | pF | |

Notes

⁽¹⁾ Pin 7 open

| CURRENT TRANSFER RATIO | | | | | | |
|----------------------------|---|--------|------|------|------|------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Current transfer ratio (1) | $I_F = 0.5 \text{ mA}, V_O = 0.4 \text{ V}, V_{CC} = 4.5 \text{ V}$ | CTR | 400 | 1600 | - | % |
| | $I_F = 1.6 \text{ mA}, V_O = 0.4 \text{ V}, V_{CC} = 4.5 \text{ V}$ | CTR | 500 | 2000 | - | % |

Notes

(1) Pin 7 open

| SAFETY AND INSULATION RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | |
|---|--|-------------------|--------------------|-------------------|--|--|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT | | |
| Climatic classification | According to IEC 68 part 1 | | 55 / 100 / 21 | | | |
| Comparative tracking index | Insulation group Illa | CTI | 175 | | | |
| Maximum rated withstanding isolation voltage | According to UL 1577, t = 1 min | V _{ISO} | 5300 | V _{RMS} | | |
| Maximum transient isolation voltage | According to DIN EN 60747-5-5 | V _{IOTM} | 8000 | V _{peak} | | |
| Maximum repetitive peak isolation voltage | According to DIN EN 60747-5-5 | V _{IORM} | 890 | V _{peak} | | |
| Isolation resistance | $T_{amb} = 25 ^{\circ}C, V_{IO} = 500 V$ | R _{IO} | ≥ 10 ¹² | Ω | | |
| Isolation resistance | $T_{amb} = 100 ^{\circ}\text{C}, V_{IO} = 500 \text{V}$ | R _{IO} | ≥ 10 ¹¹ | Ω | | |
| Output safety power | | P _{SO} | 500 | mW | | |
| Input safety current | | I _{SI} | 300 | mA | | |
| Input safety temperature | | T _S | 175 | °C | | |
| Creepage distance | DIP-8 | | ≥ 7 | mm | | |
| Clearance distance | DIF-0 | | ≥ 7 | mm | | |
| Creepage distance | SMD-8, option 7, | | ≥ 8 | mm | | |
| Clearance distance | SMD-8, option 9 | | ≥ 8 | mm | | |
| Insulation thickness | | DTI | ≥ 0.4 | mm | | |

Note

As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with
the safety ratings shall be ensured by means of protective circuits.

[•] Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.



| SWITCHING CHARACTERISTICS | | | | | | |
|--|---|------------------|------|------|------|------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Propagation delay time to logic low at output | $I_F = 0.5 \text{ mA}, R_L = 4.7 \text{ k}\Omega$ | t _{PHL} | - | 6 | 25 | μs |
| | $I_F = 12 \text{ mA}, R_L = 270 \Omega$ | t _{PHL} | - | 0.6 | 1 | μs |
| Propagation delay time to logic high at output | $I_F = 0.5 \text{ mA}, R_L = 4.7 \text{ k}\Omega$ | t _{PLH} | - | 4 | 60 | μs |
| Propagation delay time to logic high at output | $I_F = 12 \text{ mA}, R_L = 270 \Omega$ | t _{PLH} | - | 1.5 | 7 | μs |

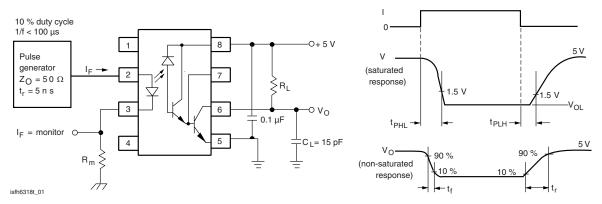


Fig. 1 - Switching Test Circuit

| COMMON MODE TRANSIENT IMMUNITY | | | | | | |
|--|---|-----------------|------|------|------|------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Common mode transient immunity, logic high level output ⁽¹⁾ | $I_F = 0$ mA, $R_L = 2.2$ k Ω , $R_{CC} = 0$, $ V_{CM} = 10$ V_{P-P} | CM _H | - | 500 | - | V/µs |
| Common mode transient immunity, logic low level output (1) | I_F = 16 mA, R_L = 2.2 kΩ, R_{CC} = 0, $ V_{CM} $ = 10 V_{P-P} | CM _L | - | -500 | - | V/µs |

Note

(2) In applications where dV/dt may exceed 50 000 V/ μ s (such as state discharge) a series resistor, R_{CC} should be included to protect I_C from destructively high surge currents. The recommend value is R_{CC} \cong [(1 V)/(0.15 I_F (mA)] k Ω .

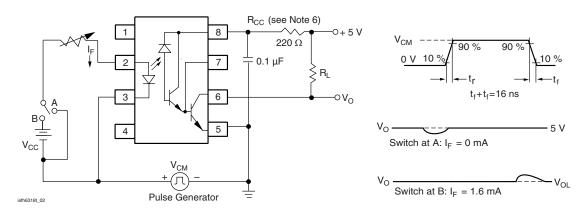


Fig. 2 - Test Circuit for Transient Immunity and Typical Waveforms



TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

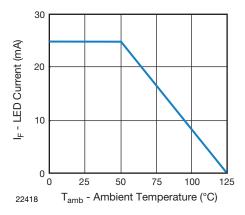


Fig. 3 - Permissible Forward LED Current vs. Temperature

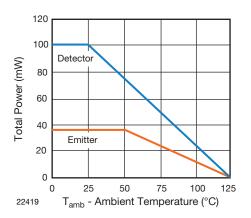
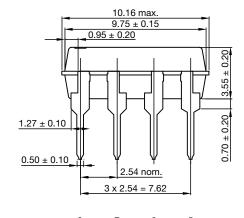
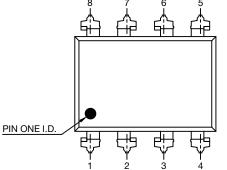


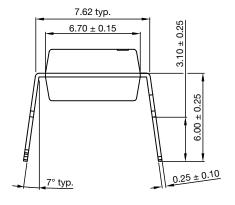
Fig. 4 - Permissible Power Dissipation vs. Temperature

PACKAGE DIMENSIONS (in millimeters)

DIP-8



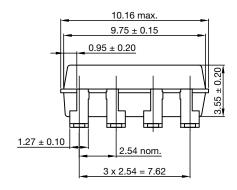


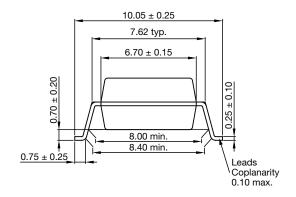


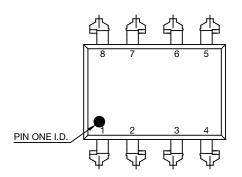
22672



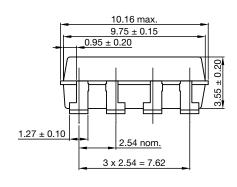
SMD-8, Option 7

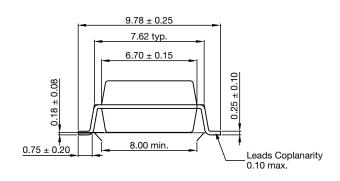


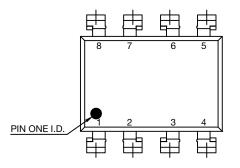




SMD-8, Option 9







22675

22674

PACKAGE MARKING

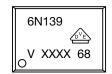


Fig. 3 - Example of 6N139-X017T

Note

- XXXX = LMC (lot marking code)
- VDE logo is only marked on option 1 parts
- Tape and reel suffix (T) is not part of the package marking

PACKING INFORMATION (in millimeters)

Tube

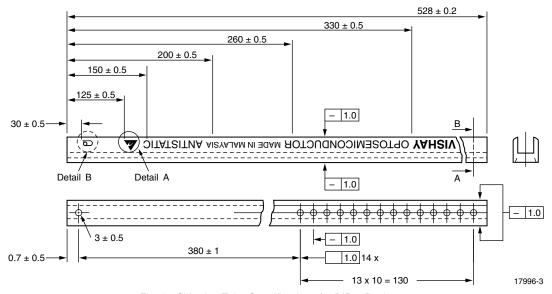


Fig. 4 - Shipping Tube Specifications for DIP-8 Packages

| DEVICES PER TUBES | | | | | |
|-------------------|------------|-----------|-----------|--|--|
| TYPE | UNITS/TUBE | TUBES/BOX | UNITS/BOX | | |
| DIP-8 | 50 | 40 | 2000 | | |

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DIP-8

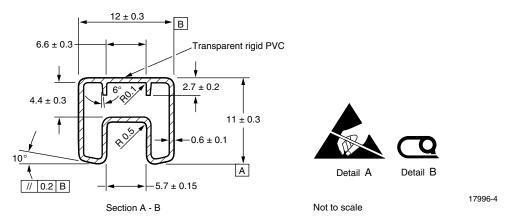


Fig. 5 - Tube Shipping Medium

Tape and Reel

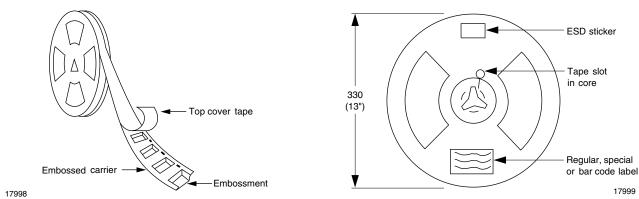


Fig. 6 - Tape and Reel Shipping Medium

Fig. 7 - Tape and Reel Shipping Medium

SMD-8 (option 7)

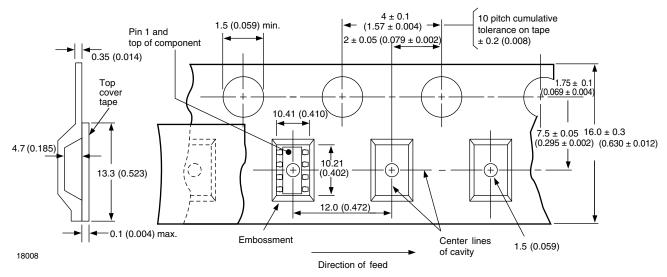


Fig. 8 - Tape and Reel Packing (1000 pieces on Reel)

SMD-8 (option 9)

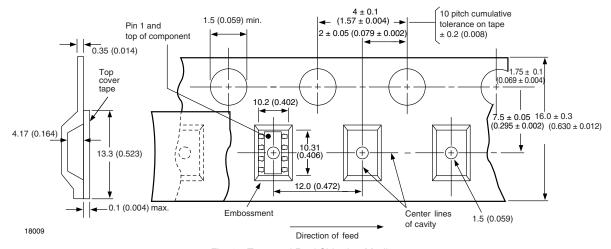


Fig. 9 - Tape and Reel Shipping Medium

SOLDER PROFILES

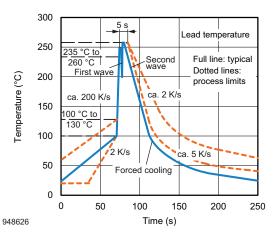


Fig. 10 - Wave Soldering Double Wave Profile According to J.STD-020 for DIP-8 Devices

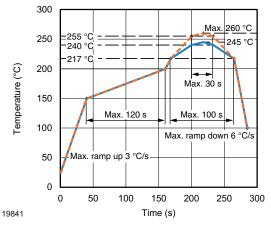


Fig. 11 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD-8 Devices

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2 Floor life: unlimited

Conditions: T_{amb} < 30 °C, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



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